

Low Voltage, Dual DPDT in miniQFN16

DESCRIPTION

The DG2599 is a CMOS Dual DPDT (Dual Double Pole Double Throw) analog switch that operates over a wide voltage range of 1.65 V to 5 V. It is optimized for portable applications switching audio, SIM card signals, and other low power signals.

The DG2599 features low ON resistance of 2.8 Ω at 3 V power supply, fast switching speed, and low power consumption even when control logic signals are below V_{+} power supply voltage. The well matched dual DPDT switches conduct signals equally in both directions. The DG2599 is designed to guarantee break before make switching.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with lead (Pb)-free device terminations. DG2599 are offered in a miniQFN package. The miniQFN package has a nickel palladium- gold device termination and is represented by the lead (Pb)-free “-E4” suffix. The nickel-palladium-gold device terminations meet all JEDEC® standards for reflow and MSL ratings.

FEATURES

- Halogen-free according to IEC 61249-2-21 definition
- Low voltage operation: 1.65 V to 5.5 V
- Low on-resistance: 2.8 Ω at $V_{+} = 3$ V
- Power off protection on COM1 and COM2 pins
- Latch up current great than 300 mA per JESD78
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



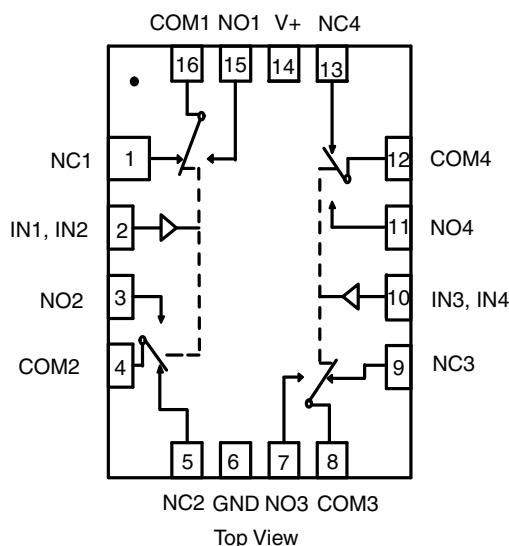
RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Cellular phones
- PMPs and PDAs
- Modems and peripherals
- Computers and ebooks
- Tablet devices
- Displays and gaming
- STB

ORDERING INFORMATION

PART NUMBER	PACKAGE
DG2599DN-T1-GE4	miniQFN16 1.8 mm x 2.6 mm

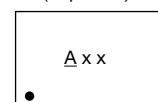


TRUTH TABLE (DG2599)

LOGIC	NC1, 2, 3 AND 4	NO 1, 2, 3 AND 4
0	ON	OFF
1	OFF	ON

Device Marking: A xx
xx = Date/Lot Traceability Code

(Top View)



Pin 1

Note: Pin 1 has long lead

**ABSOLUTE MAXIMUM RATINGS** ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Reference to GND	V+	-0.3 to +6	V
	IN, COM, NC, NO ^a	-0.3 to (V+ + 0.3)	
Current (any terminal except NO, NC or COM)		30	
Continuous current (NO, NC, or COM)		± 300	mA
Peak current (pulsed at 1 ms, 10 % duty cycle)		± 500	
Storage temperature (D suffix)		-65 to +150	$^{\circ}\text{C}$
Package solder reflow conditions ^d	miniQFN16	250	
Power dissipation (packages) ^b	miniQFN16 ^c	525	mW

Note

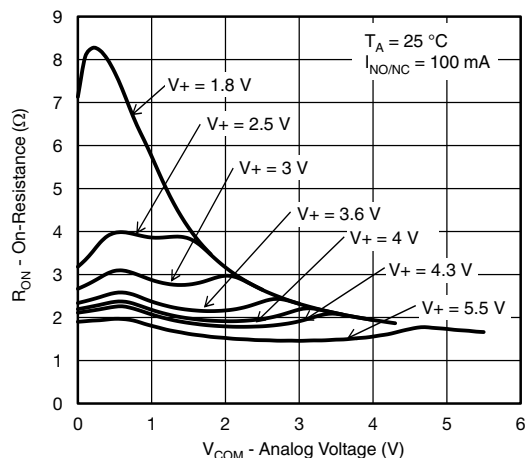
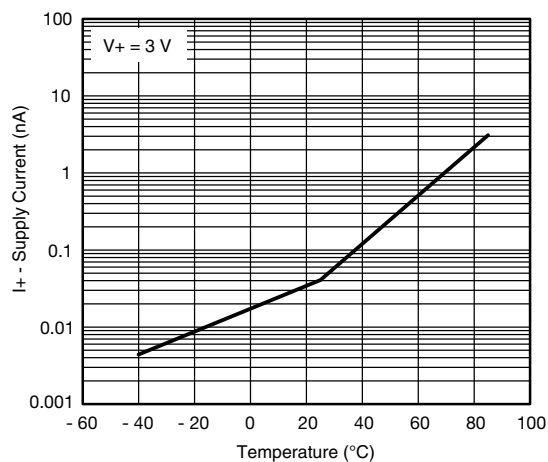
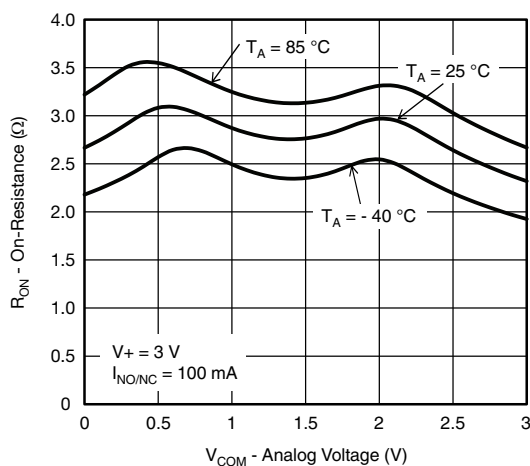
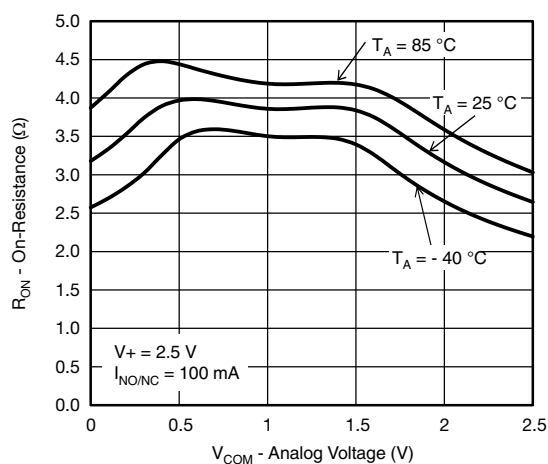
- a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings
- b. All leads welded or soldered to PC board
- c. Derate 6.6 mW/ $^{\circ}\text{C}$ above 70 $^{\circ}\text{C}$
- d. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

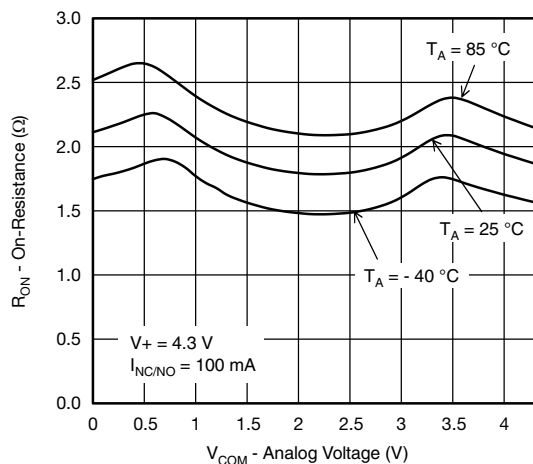
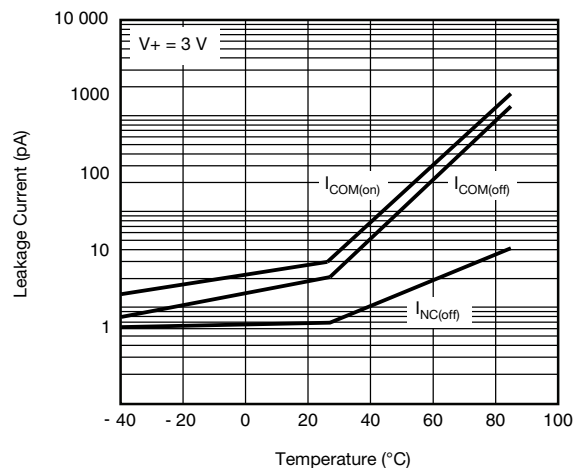
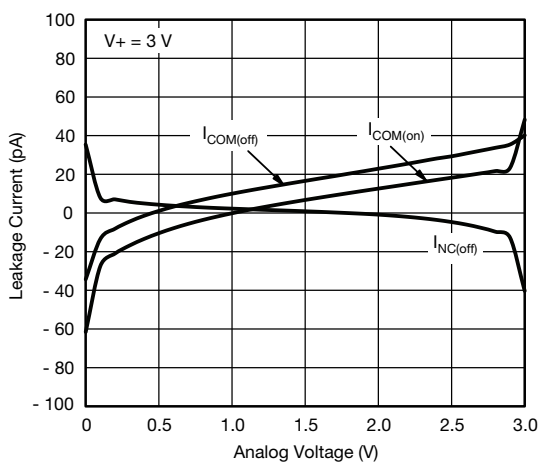
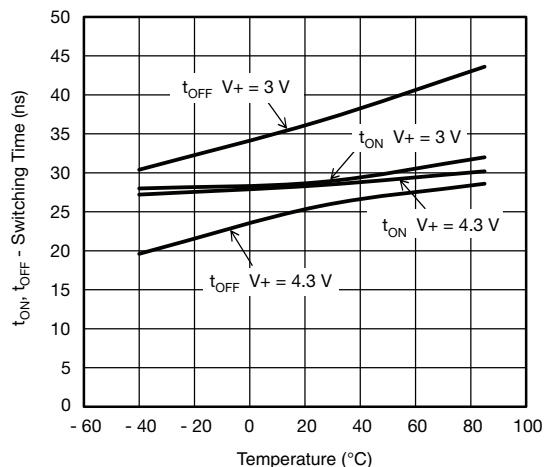
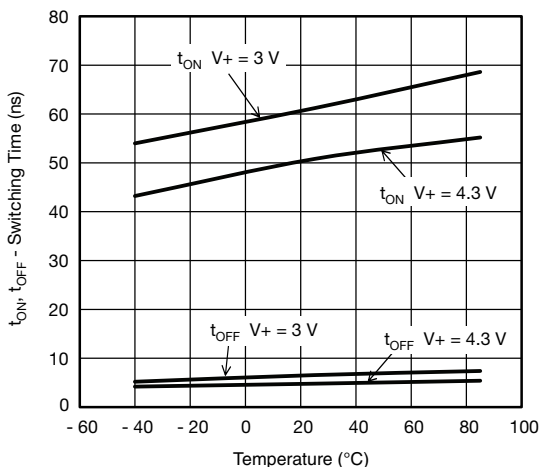
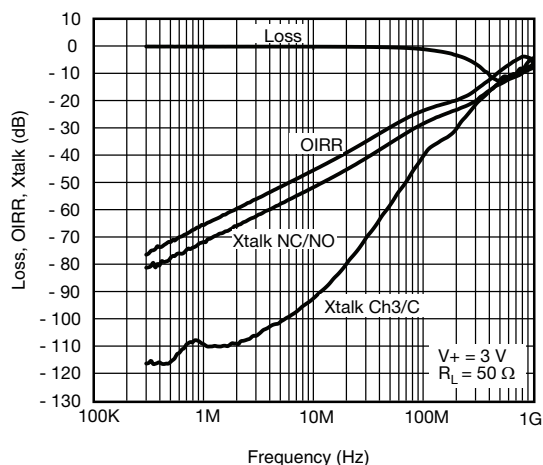
ELECTRICAL CHARACTERISTICS ($V_+ = 3\text{ V}$)

PARAMETER	TEST CONDITIONS	TEMP.	MIN.	TYP.	MAX.	UNIT
Power Supply and Signal						
V+ supply voltage		Full	1.65	-	5.5	V
V+ supply current	V _{IN} = 0 or V+	Full	-	0.001	2	μA
Analog signal range		Full	0	-	V+	V
Switch On-Resistance and Leakage						
Drain-source on-resistance	V+ = 3 V, I _{NO/NC} = 100 mA, V _{COM} = 0.9 V, 2.3 V	Room	-	2.8	3.3	W
		Full	-	-	3.6	
On-resistance flatness	V+ = 3 V, I _{NO/NC} = 100 mA, V _{COM} = 0 to V+	Room	-	0.24	1.1	W
		Full	-	-	1.3	
Switch off leakage current	V+ = 4.3 V, V _{NO/NC} = 0.3 V/4 V, V _{COM} = 4 V / 0.3 V	Room	-10	0.1	10	nA
		Full	-100	-	100	
Channel on-leakage current	V+ = 4.3 V, V _{NO/NC} and V _{COM} = 0.3 V / 4 V	Room	-10	0.1	10	nA
		Full	-100	-	100	
Digital Control						
Input, high voltage	V+ = 4.3 V	Full	1.6	-	-	V
	V+ = 3 V		1.3	-	-	
Input, low voltage	V+ = 4.3 V	Full	-	-	0.6	
	V+ = 3 V		-	-	0.5	
Input, bias current	V _{IN} = V+	Full	-1	0.01	1	μA
Dynamic Characteristics						
Turn on-time	V _{COM} or V _{NO/NC} = 3 V, R _L = 50 Ω, C _L = 35 pF	Room	-	-	90	ns
		Full	-	-	115	
Turn off-time	V _{COM} or V _{NO/NC} = 3 V, R _L = 50 Ω, C _L = 35 pF	Room	-	-	70	
		Full	-	-	85	
Break before make time	V _{COM} or V _{NO/NC} = 3 V, R _L = 50 Ω, C _L = 35 pF	Room	2	-	-	ns
		Full	2	-	-	
Charge injection	C _L = 1 nF, R _{GEN} = 0 Ω	Room	-	± 10	-	pC
Off isolation	R _L = 50 Ω, C _L = 5 pF, f = 1 MHz		-	-66	-	dB
Crosstalk	R _L = 50 Ω, C _L = 5 pF, f = 1 MHz, non-adjacent channels		-	-110	-	
3 dB bandwidth	C _L = 5 pF, R _L = 50 Ω		-	186	-	MHz

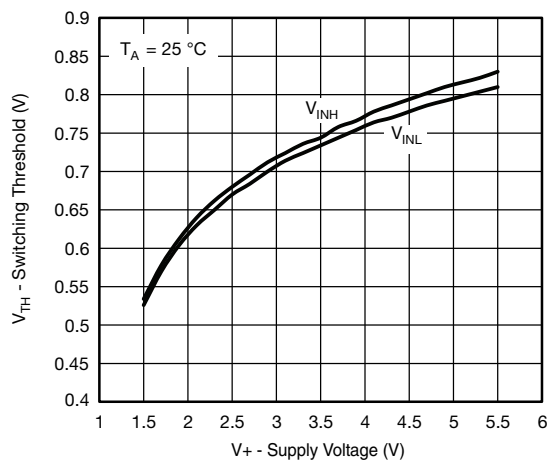
**ELECTRICAL CHARACTERISTICS ($V_+ = 3\text{ V}$)**

PARAMETER	TEST CONDITIONS	TEMP.	MIN.	TYP.	MAX.	UNIT
Source off capacitance	$V_{IN} = 0$ or V_+ , $f = 1\text{ MHz}$		-	9	-	pF
Channel on capacitance	$V_{IN} = 0$ or V_+ , $f = 1\text{ MHz}$		-	26	-	

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted) **R_{ON} vs. V_{COM} and Single Supply Voltage****Supply Current vs. Temperature** **R_{ON} vs. Analog Voltage and Temperature** **R_{ON} vs. Analog Voltage and Temperature**

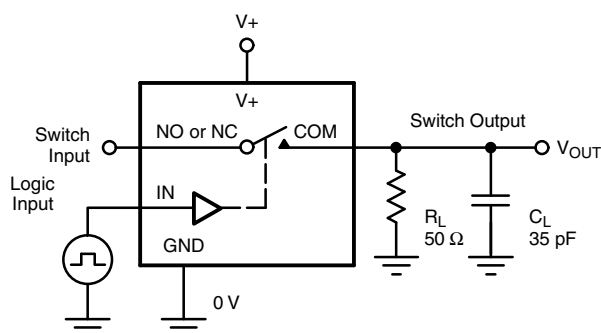

 R_{ON} vs. Analog Voltage and Temperature

Leakage Current vs. Temperature
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Leakage vs. Analog Voltage

(NO) Switching Time vs. Temperature

(NC) Switching Time vs. Temperature


Insertion Loss, Off Isolation and Crosstalk



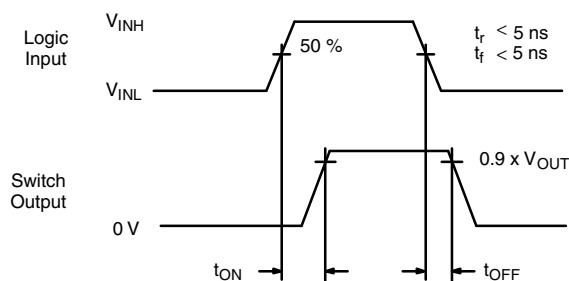
Switching Threshold vs. Supply Voltage

TEST CIRCUITS



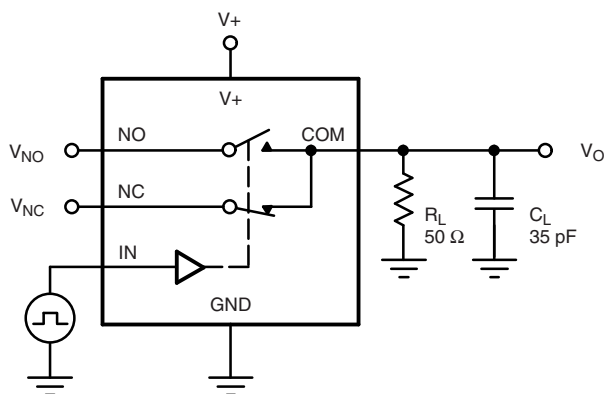
C_L (includes fixture and stray capacitance)

$$V_{OUT} = V_{COM} \left(\frac{R_L}{R_L + R_{ON}} \right)$$

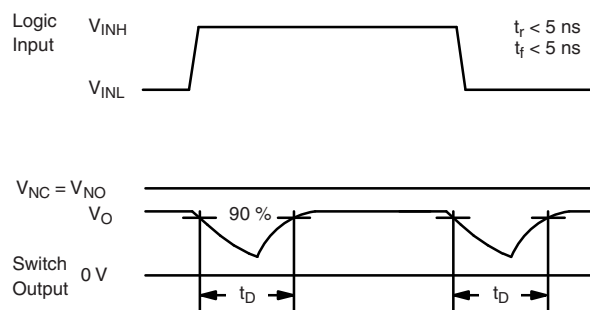


Logic "1" = Switch On
Logic input waveforms inverted for switches that have the opposite logic sense.

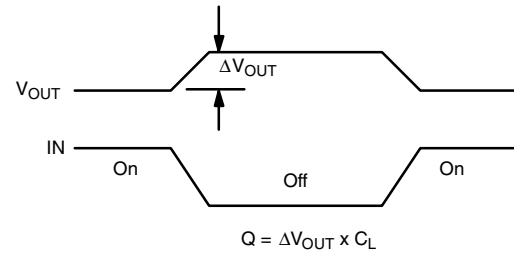
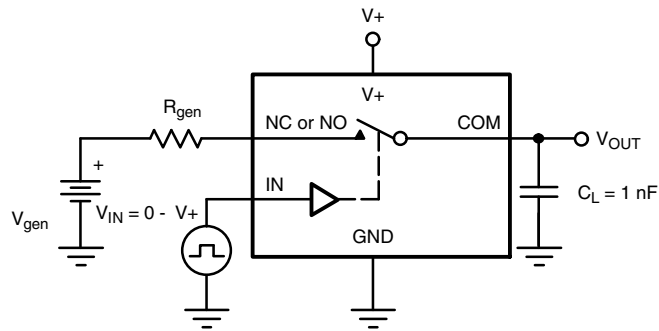
Switching Time



C_L (includes fixture and stray capacitance)



Break-Before-Make Interval

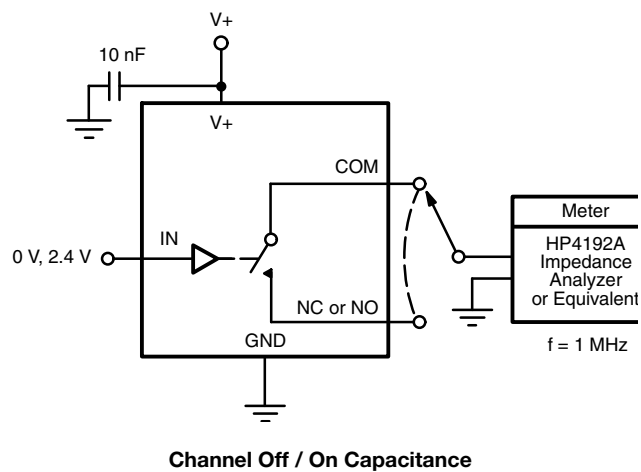
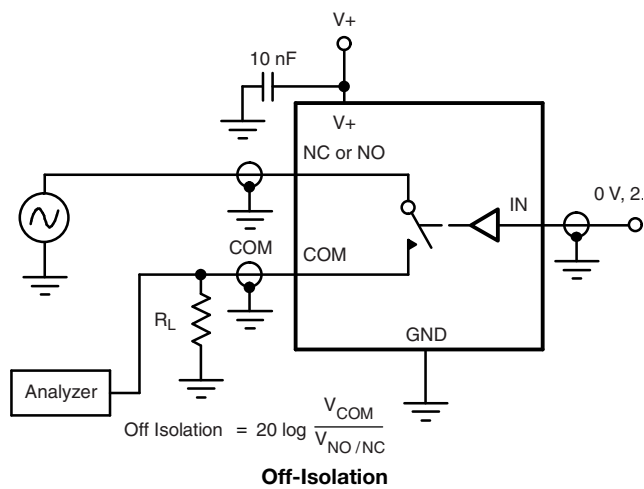


IN depends on switch configuration: input polarity determined by sense of switch.

Charge Injection

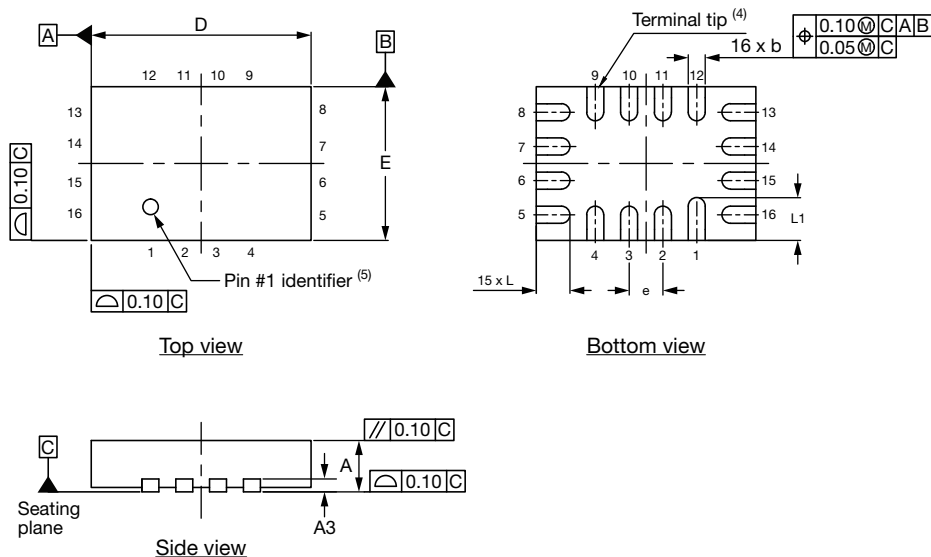


TEST CIRCUITS



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?267667.

Thin miniQFN16 Case Outline



DIMENSIONS	MILLIMETERS ⁽¹⁾			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.50	0.55	0.60	0.020	0.022	0.024
A1	0	-	0.05	0	-	0.002
A3	0.15 ref.			0.006 ref.		
b	0.15	0.20	0.25	0.006	0.008	0.010
D	2.50	2.60	2.70	0.098	0.102	0.106
e	0.40 BSC			0.016 BSC		
E	1.70	1.80	1.90	0.067	0.071	0.075
L	0.35	0.40	0.45	0.014	0.016	0.018
L1	0.45	0.50	0.55	0.018	0.020	0.022
N ⁽³⁾	16			16		
Nd ⁽³⁾	4			4		
Ne ⁽³⁾	4			4		

Notes

- (1) Use millimeters as the primary measurement.
- (2) Dimensioning and tolerances conform to ASME Y14.5M. - 1994.
- (3) N is the number of terminals. Nd and Ne is the number of terminals in each D and E site respectively.
- (4) Dimensions b applies to plated terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.
- (5) The pin 1 identifier must be existed on the top surface of the package by using identification mark or other feature of package body.
- (6) Package warpage max. 0.05 mm.

ECN: T16-0226-Rev. B, 09-May-16
DWG: 6023

Mounting Footprint
Dimensions in mm (inch)



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